

74HC05

HEX INVERTERS WITH OPEN DRAIN OUTPUTS

Description

The 74HC05 provides provides six independent inverters with open drain outputs. The device is designed for operation with a power supply range of 2.0V to 6.0V.

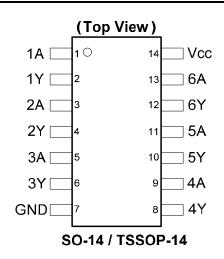
The gates perform the Boolean function:

 $\mathsf{Y}=\overline{\mathsf{A}}$

Features

- Wide Supply Voltage Range from 2.0V to 6.0V
- Sinks 4mA at V_{CC} = 4.5V
- CMOS Low Power Consumption
- Schmitt Trigger Action at All Inputs
- ESD Protection Exceeds JESD 22
 - 200-V Machine Model (A115-A)
 - 2000-V Human Body Model (A114-A)
 - Exceeds 1000-V Charged Device Model (C101C)
- Range of Package Options SO-14 and TSSOP-14
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Pin Assignments



Applications

- General Purpose Logic
 - Wide array of products such as:
 - PCs, Networking, Notebooks, Netbooks
 - Computer Peripherals, Hard Drives, CD/DVD ROM
 - TV, DVD, DVR, Set Top Box

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

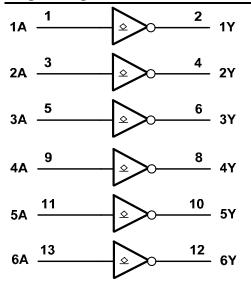
See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



Pin Descriptions

Pin Number	Pin Name	Function
1	1A	Data Input
2	1Y	Data Output
3	2A	Data Input
4	2Y	Data Output
5	3A	Data Input
6	3Y	Data Output
7	GND	Ground
8	4Y	Data Output
9	4A	Data Input
10	5Y	Data Output
11	5A	Data Input
12	6Y	Data Output
13	6A	Data Input
14	V _{CC}	Supply Voltage

Logic Diagram



Function Table

Input	Output
A	Y
Н	L
L	Z



Absolute Maximum Ratings (Note 4) (@T_A = +25°C, unless otherwise specified.)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD CDM	Charged Device Model ESD Protection	1	KV
ESD MM	Machine Model ESD Protection	200	V
V _{CC}	Supply Voltage Range	-0.5 to +7.0	V
VI	Input Voltage Range (Note 5)	-0.5 to +7.0	V
I _{IK}	Input Clamp Current VI < -0.5V or Vi > V _{CC} + 0.5V	±20	mA
I _{OK}	Output Clamp Current $V_O < -0.5V$ or $V_O > V_{CC} + 0.5V$	±20	mA
lo	Continuous Output Current - 0.5V < V _O V _{CC} + 0.5V	+/- 25	mA
Icc	Continuous Current Through V _{CC}	50	mA
I _{GND}	Continuous Current Through GND	-50	mA
TJ	Operating Junction Temperature	-40 to +150	°C
T _{STG}	Storage Temperature	-65 to +150	°C
Ртот	Total Power Dissipation	500	mW

Notes: 4. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.

5. Input Voltage cannot exceed V_{CC} to the extent the Maximum clamp current is exceeded

Recommended Operating Conditions (Note 6) (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	Supply Voltage		2.0	6.0	V
VI	Input Voltage		0	Vcc	V
Vo	Output Voltage		0	V _{CC}	V
		V _{CC} = 2.0V		625	
Δt/ΔV	Input transition rise or fall rate	V_{CC} = 4.5V		140	ns/V
		V_{CC} = 6.0V		85	
TA	Operating free-air temperature		-40	+125	°C

Note: 6. Unused inputs should be held at V_{CC} or Ground.

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Symbol Parameter		Test Conditions	$T_{A} = -40^{\circ}C \text{ to } +85^{\circ}C$		C to +85°C	T _A = -40°C	to +125°C	Unit
Symbol Parameter	Parameter	Test Conditions	Vcc	Min	Max	Min	Max	Unit
			2.0V	1.5		1.5		
VIH	High-level Input Voltage		4.5V	3.15		3.15		V
	vollage		6.0V	4.2		4.2		
			2.0V		0.5		0.5	
VIL	Low-level input voltage		4.5V		1.35		1.35	V
	voltage		6.0V		1.8		1.8	
		I _{OL} = 20μA	2.0V		0.1		0.1	-
		I _{OL} = 20μA	4.5V		0.1		0.1	
Vol	Low-level Output Voltage	I _{OL} = 20µA	6.0V		0.1		0.1	V
	voltage	I _{OL} = 4mA	4.5V		0.33		0.44	
		I _{OL} = 5.2mA	6.0V		0.33		0.44	
I _{OZ}	Z State Leakage Current	V _O =0 to 6.0V V _I =GND or 6.0V	6.0V		± 5.0		± 10	μA
l	Input Current	V _I =GND to 5.5V	6.0V		± 1		± 1	μA
I _{CC}	Supply Current	$V_{I} = GND \text{ or } V_{CC},$ $I_{O}=0$	6.0V		20		40	μA



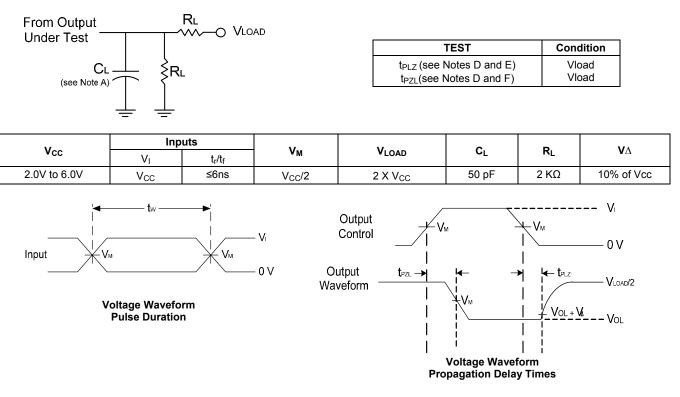
Switching Characteristics

Symbol Parameter	Test Conditions	Test	Ma a	-	T _A = +25°C	;	-40°C to +85°C	-40°C to +125°C	Unit
		Vcc	Min	Тур	Max	Max	Max	Unit	
	top 100	Figure 1 C _L = 50 pF	2.0V	_	25	90	115	125	
t _{PD}			4.5V	—	9	18	23	27	ns
			6.0V	_	7	15	20	23	
		Figure 1	2.0V	_	19	75	95	110	
t _t Transition time	Figure 1 - C _L = 50 pF -	4.5V	_	7	15	19	22	ns	
		6.0V	_	6	13	16	19		

Operating Characteristics (@T_A = +25°C, unless otherwise specified.)

	Parameter	Test Conditions	V _{CC} = 6V Typ	Unit
C _{pd}	Power dissipation capacitance per gate	f = 1 MHz	22	pF
CI	Input Capacitance	$V_{I} = V_{CC} - or GND$	4	pF

Parameter Measurement Information



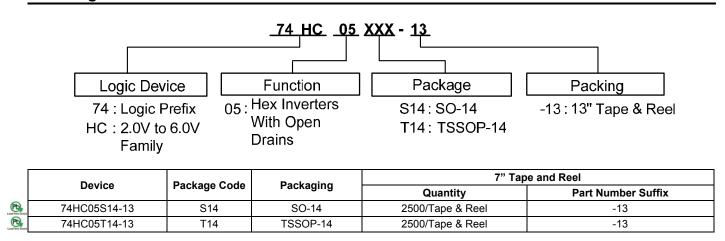
Notes: A. Includes test lead and test apparatus capacitance.

- B. All pulses are supplied at pulse repetition rate ≤ 1 MHz.
- C.The inputs are measured one at a time with one transition per measurement.
- D. For the open drain device t_{PLZ} and t_{PZL} are the same as $t_{\mathsf{PD.}}$
- E. t_{PZL} is measured at $V_{\text{M}}.$
- F. $t_{PLZ}\,$ is measured at V_OL +V_{\Delta.}
- D. A Thevenin equivalent load may be used in place of V_{CC} X 2 and resistor divider.

Figure 1 Load Circuit and Voltage Waveforms

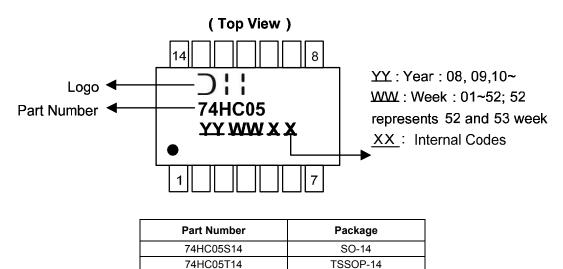


Ordering Information



Marking Information

(1) SO-14, TSSOP-14

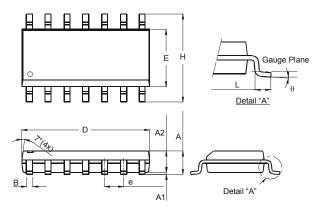




Package Outline Dimensions (All dimensions in mm.)

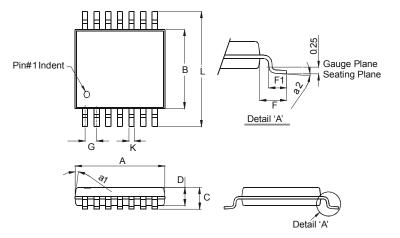
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

Package Type: SO-14



	SO-14					
Dim	Min	Max				
Α	1.47	1.73				
A1	0.10	0.25				
A2	1.45	Тур				
В	0.33	0.51				
D	8.53	8.74				
Е	3.80	3.99				
е	1.27	Тур				
Н	5.80	6.20				
L	0.38	1.27				
θ	0°	8°				
All Di	mensions	s in mm				

Package Type: TSSOP-14

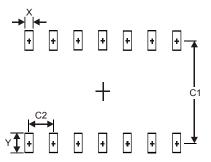


	TSSOP-14						
Dim	Min Max						
a1	7° (4X)					
a2	0°	8°					
Α	4.9	5.10					
В	4.30	4.50					
С	_	1.2					
D	0.8	1.05					
F	1.00	Тур					
F1	0.45	0.75					
G	0.65	Тур					
κ	0.19	0.30					
L	6.40 Typ						
All Dir	nensions	s in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.

Package Type: SO-14



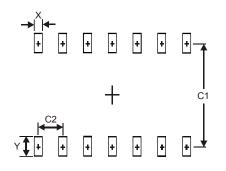
Dimensions	Value (in mm)
Х	0.60
Y	1.50
C1	5.4
C2	1.27



74HC05

Suggested Pad Layout (cont.)

Package Type: TSSOP-14



Dimensions	Value (in mm)
Х	0.45
Y	1.45
C1	5.9
C2	0.65

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